

ALD 2014

14th International Conference on Atomic Layer Deposition

www.ald-avs.org AVS®

Sponsorship and Exhibit Facts Sheet

June 15-18, 2014, Kyoto, Japan

The 14th International Conference on Atomic Layer Deposition (ALD 2014) will be a three-day meeting (preceded by one day of tutorials), dedicated to the science and technology of atomic layer deposition of thin films. This conference is sponsored by the AVS Thin Film Division.

Atomic layer deposition (ALD) is used to fabricate ultrathin and conformal thin film structures for many semiconductor and thin film device applications. A unique attribute of ALD is that it uses sequential self-limiting surface reactions to achieve control of film growth in the monolayer or sub-monolayer thickness regime. ALD is receiving attention for its potential applications in advanced high dielectric constant (high- k) gate oxides, storage capacitor dielectrics and copper diffusion barriers in advanced electronic devices, as well as for solar energy, flexible electronics, photonics and biological applications. It is of interest for any advanced technologies that require control of film structure in the nanometer or sub-nanometer scale.

The ALD conference has steadily grown in number of participants, from 80 at its initiation in 2001 to 250-350 participants in the past years. Preceding ALD conferences were held in:

- 2001: Monterey (US)
- 2002: Seoul (Korea)
- 2003: San Jose (US)
- 2004: Helsinki (Finland)
- 2005: San Jose (US)
- 2006: Seoul (Korea)
- 2007: San Diego (US)
- 2008: Bruges (Belgium)
- 2009: Monterey (US)
- 2010: Seoul (Korea)
- 2011: Boston (US)
- 2012: Dresden (Germany)
- 2013: San Diego (US)

Questions

More information on ALD 2014 is available at www.ald2014.org. You may also contact secretariat of ALD 2014 sponsord@ald2014.org

Location

HOTEL GRANVIA KYOTO
JR Kyoto Station, Karasuma Chuo-guchi, Shiokoji-sagaru
Karasumadori, Shimogyo-ku, Kyoto 600-8216 Japan

Sponsorship Opportunities

Increase your visibility and stand out from your competitors. Choose sponsor level and benefits below.

Exhibit Dates

Monday, June 16, 2014-Wednesday, June 18, 2014

Move-In

Sunday, June 15, 2014

Move-Out

Wednesday, June 18, 2014

Exhibit Fee

Includes: 2 back panels and power (500W/space).

- (1) Space JPY 100,000
- (2) Spaces JPY 200,000

Exhibit Selection

Space selections will be assigned on a first-come, first-served. Please note space is limited to 50 spaces.

Exhibit Space Includes

- One technical session badge per space. It is transferable and will automatically be issued in the name of the exhibiting company. Please note that the exhibit will take place during breaks and should require only one representative per space. Other representatives would need to register as conference attendees at www.ald2014.org.
- One abstract book, one conference DVD, plus any other conference materials.
- Post meeting attendee list.

ALD 2014 Sponsorship Form

Sponsorship Levels

- Silver (JPY 100,000)**—Sponsorship includes recognition on the ALD 2014 Website (with logo link) and inclusion in ALD product guide (published in the abstract book and conference DVD).
- Gold (JPY 200,000)**—Sponsorship includes all of the above, plus a one-page black and white ad in the abstract book and recognition on general conference signage/materials.
- Platinum Sponsors (JPY 400,000)**—Sponsorship includes all of the above, plus a banner ad on the ALD website as well as one oral slide presentation during the technical symposium that states your company's business focus/area of expertise.

- | | | |
|---------------------------------|--------------------------------------|---|
| Breaks (6 Sponsors): | <input type="checkbox"/> JPY 300,000 | Congress Bag (2 sponsors): <input type="checkbox"/> JPY 300,000 Sold Out |
| Lunches (3 sponsors): | <input type="checkbox"/> JPY 350,000 | Neck Strap for ID badge <input type="checkbox"/> JPY 200,000 Sold Out |
| Poster Receptions (4 sponsors): | <input type="checkbox"/> JPY 400,000 | Advertise on Abstract Book (one-page black and white) |
| Welcome Reception (2 sponsors): | <input type="checkbox"/> JPY 400,000 | <input type="checkbox"/> JPY 100,000 |
| Congress Ballpoint Pen | <input type="checkbox"/> JPY 200,000 | Advertise on Abstract Book (half-page black and white) |
| Congress Sticky Note | <input type="checkbox"/> JPY 200,000 | <input type="checkbox"/> JPY 50,000 |
| Congress Memo Pad | <input type="checkbox"/> JPY 200,000 | |

Please contact secretariat of ALD 2014, sponsord@ald2014.org, with any questions or for any other form(s) of sponsorship that you may like to suggest.

Company Information

Company: _____

Contact Name: _____

Address: _____

City: _____ State: _____

Country: _____ Postal Code: _____

Phone: _____ Fax: _____

E-mail _____

Payment Information

Payment Method: Bank Transfer Credit Card (Credit Card Payment form can be downloaded separately)

Bank Name: SUMITOMO MITSUI BANKING CORPORATION

Branch: HIBIYA BRANCH

Account Number: 8776134

Account Name: ALD2014 Sponsord

Swift Code: SMBCJPJT

Address: 1-15-1, Nishi-Shimbashi, Minato-ku, Tokyo 105-0003 Japan

Return form to: Secretariat of ALD2014

(c/o) Japan Convention Service, Inc.

Tel. +81-3-3502-6872 / Fax +81-3-3502-1888

E-mail sponsord@ald2014.org

~~ALD 2014 Exhibit Form~~ **Sold Out**

Exhibitor Company Information

Company: _____

Contact Name: _____

Address: _____

City: _____ State: _____

Country: _____ Postal Code: _____

Phone: _____ Fax: _____

E-mail _____

Exhibit Fee

(1) Space (includes 2 back panels, and 500w.) JPY 100,000

(2) Spaces (includes 4 back panels, and 1000w.) JPY 200,000

Please contact me about extra power requirements.

Exhibit Space Selection

Space selections will be assigned on a first-come, first-served. Please note space is limited to 50 spaces.

Exhibit Payment Information

For cancellations received on or before April 15, 2014, all sums, less a service charge of JPY 10,000 will be returned to the exhibitor. After April 15, 2014, no refunds will be made. Any refunds for cancelled exhibit space will be made after the completion of the Exhibition.

Signature: _____ Date: _____

Payment Method: Bank Transfer Credit Card (Credit Card Payment form can be downloaded separately)

Bank Name: SUMITOMO MITSUI BANKING CORPORATION

Branch: HIBIYA BRANCH

Account Number: 8776134

Account Name: ALD2014 Sponsord

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